

EAITRAA2



Features

- High sensitivity
- Cut-Off visible wavelength
- Compliance Halogen Free(Br < 900ppm, Cl < 900ppm, Br+Cl < 1500ppm)
- Compliance with EU REACH
- This product itself will remain within RoHS compliant version.
- Optimal Sensing Distance: 4 mm
- Package size : 4.0*3.0*2.0 mm

Description

- **EAITRAA2** is a compact-package, phototransistor output, reflective photo interrupter, with emitter and detector facing the same direction in a molding that provides non-contact sensing. The compact package series is a result of unique technology, combining transfer and injection molding, that also blocks visible light to minimize false detection. This device has a long focal distance for this family of devices and has a leadless (T&R) package, suitable for reflow soldering.

Applications

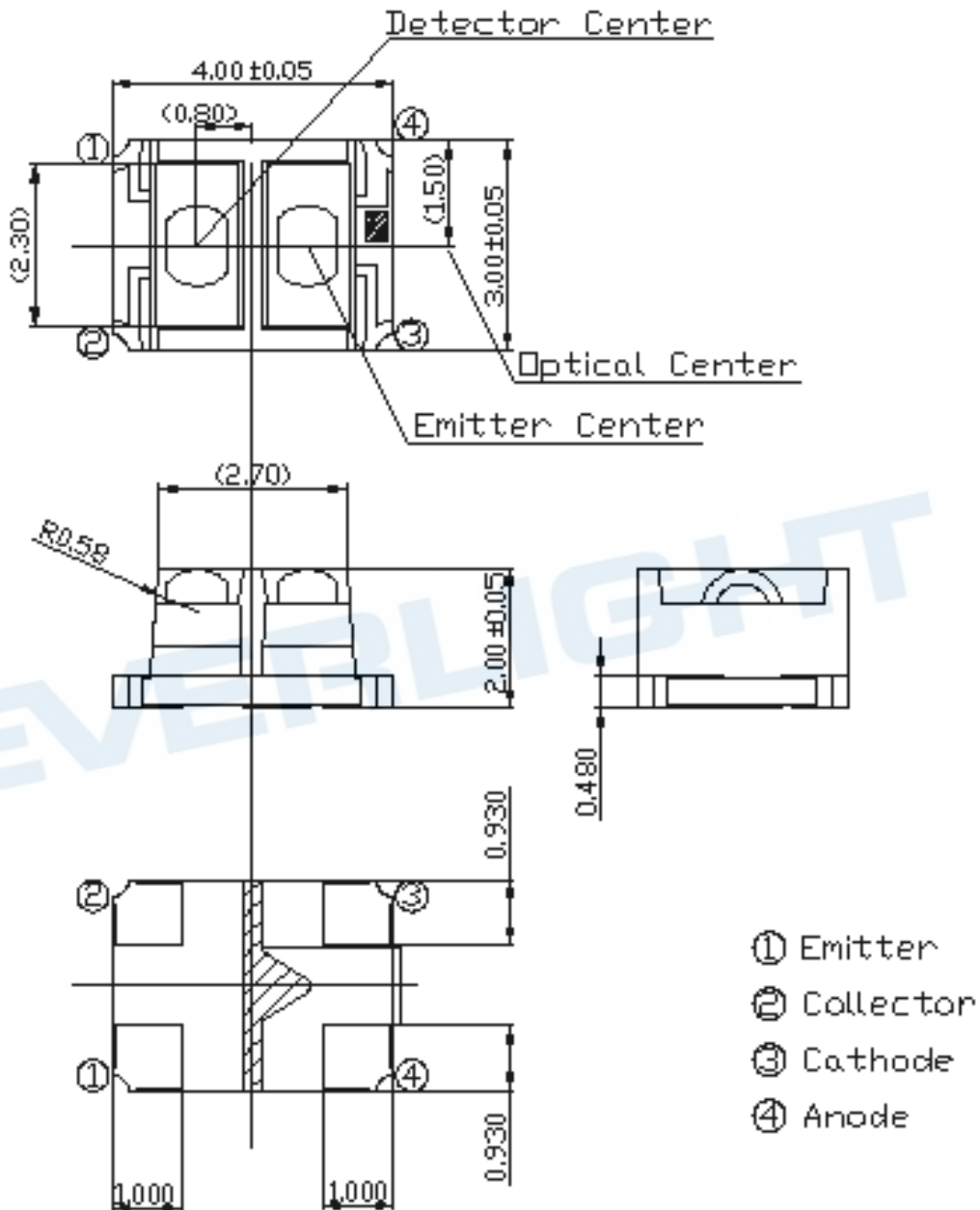
- Detection of object presence or motion.
- Example : printer, optical storage, Projector

Device Selection Guide

Device No.	Chip Material	Lens Color
IR	GaAs	Black clear
PT	Silicon	Black clear

Package Dimensions

Top View



● Notes:

1. All dimensions are in millimeters
2. Tolerances unless dimensions ±0.1mm
3. Lead spacing is measured where the lead emerge from the package
4. Product mass : approx. 0.025g

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit
Input	Power Dissipation at(or below) 25 °C Free Air Temperature	Pd	75	mW
	Reverse Voltage	V _R	5	V
	Forward Current	I _F	50	mA
	Peak Forward Current (*1) Pulse width ≤100μs, Duty cycle=1%	I _{FP}	1	A
Output	Collector Power Dissipation	P _C	75	mW
	Collector Current	I _C	50	mA
	Collector-Emitter Voltage	B V _{CEO}	30	V
	Emitter-Collector Voltage	B V _{ECO}	5	V
Operating Temperature		Topr	-25~+85	°C
Storage Temperature		Tstg	-40~+100	°C
Lead Soldering Temperature (*2) (1/16 inch form body for 5 seconds)		Tsol	260	°C

- Notes:
(*1) tw=100 μsec., T=10 msec.
(*2) t=10 Sec

Electro-Optical Characteristics (Ta=25°C)

Parameter		Symbol	Min.	Typ.	Max.	Unit	Conditions
Input	Forward Voltage	V _F	–	1.2	1.4	V	I _F =20mA
	Reverse Current	I _R	–	–	10	μA	V _R =6V
	Peak Wavelength	λ _p	–	940	–	nm	I _F =10mA
Output	Dark Current	I _{CEO}	–	1	100	nA	V _{CE} =20V
Transfer Characteristics	Collector Current	I _C (ON)	60	–	450	μA	V _{CE} =2V I _F =4mA d=4mm
		I _C (OFF)	–	–	600	nA	V _{CE} =2V I _F =4mA
	Response time	t _r	–	20	100	μs	V _{CE} =2V, I _C =100μA, RL=1kΩ, d=4mm
		t _f	–	20	100	μs	

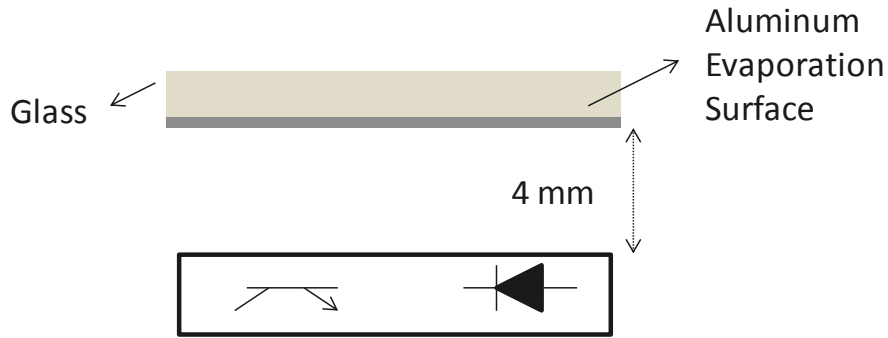
*Operating dark current may be affected by surrounding situation

Bin Range of Collector Current

Unit : (μA)

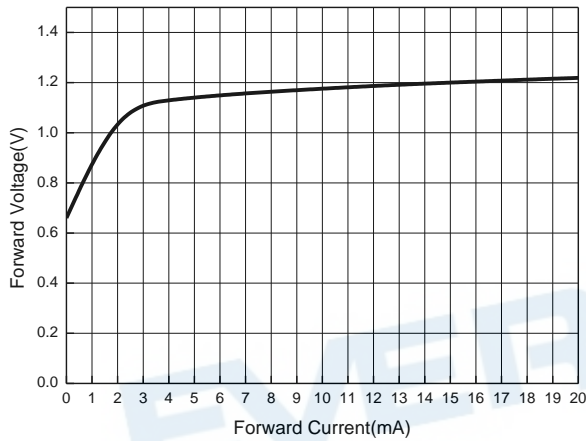
Bin number	Min	Max
A	60	120
B	100	220
C	180	350
D	310	450

Test Condition and Arrangement for Collector Current

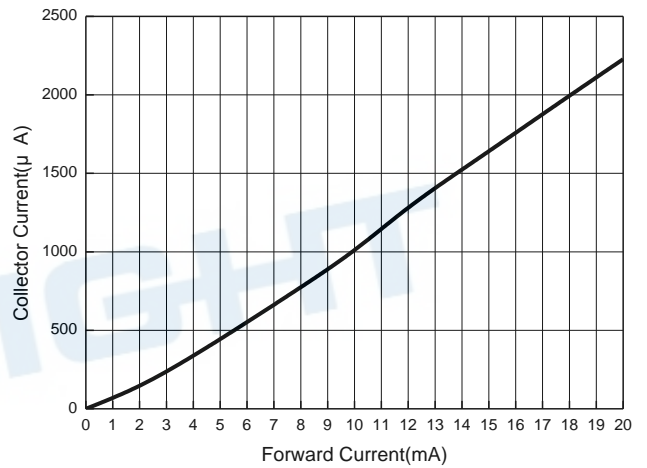


Typical Electro-Optical Characteristics Curves

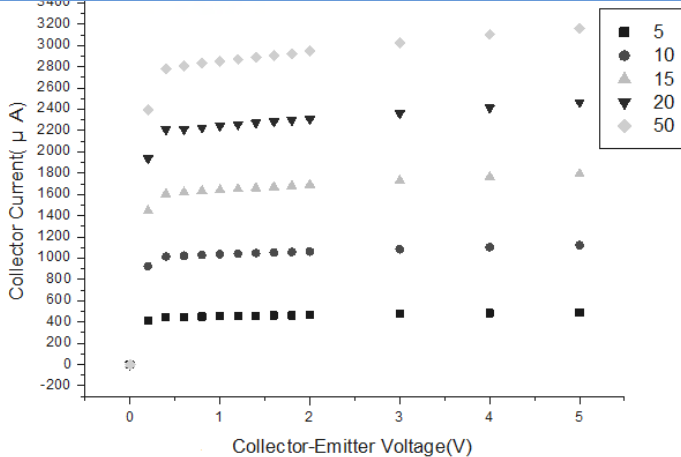
Forward Current VS. Forward Voltage



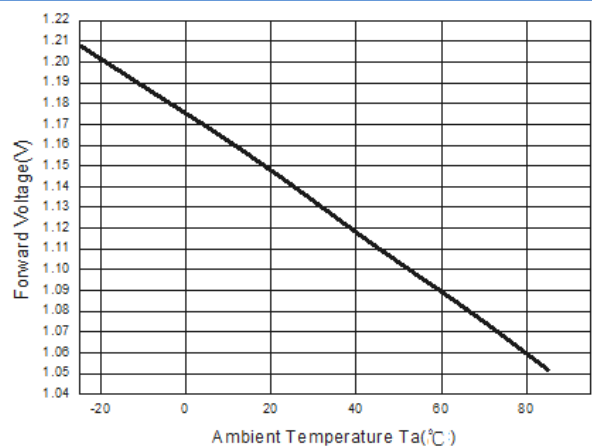
Forward Current V.S Collector Current



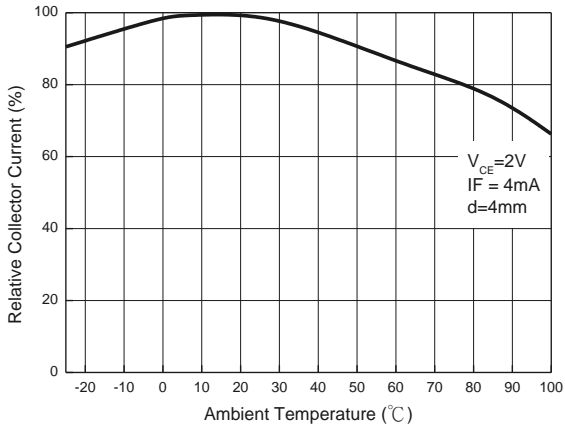
Collector Current V.S Collector-Emitter Voltage



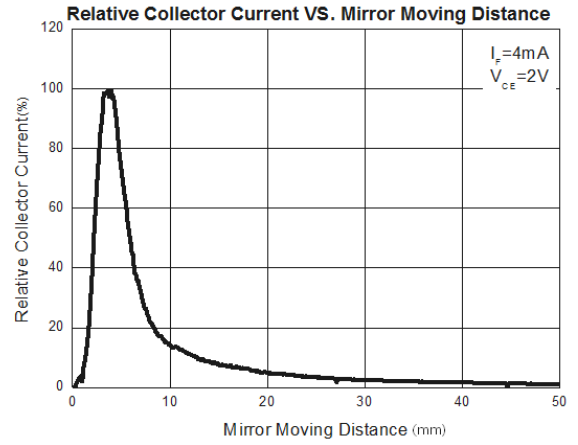
Forward Voltage V.S Ambient Temperature



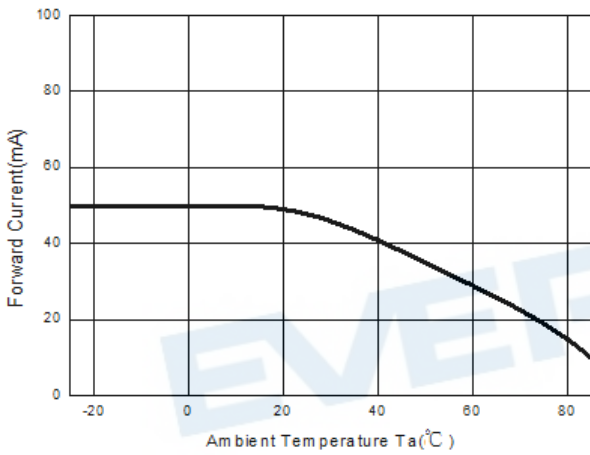
Relative Collector Current V.S
Ambient Temperature



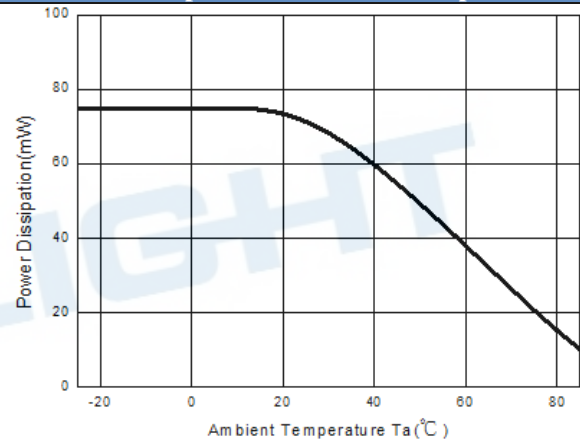
Relative Collector Current V.S Z-Moving Distance
Condition : $I_F=4\text{ mA}$ 、 $V_{CE}=2\text{ V}$



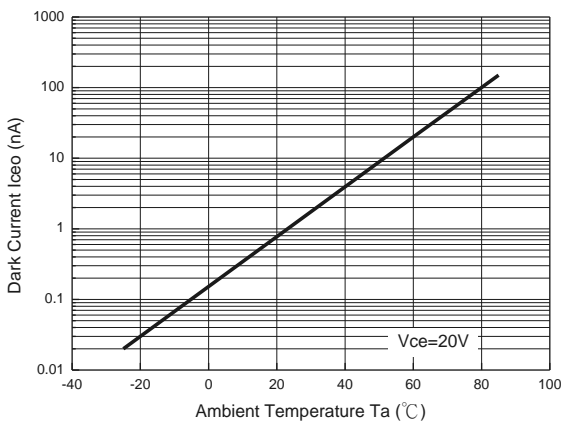
Forward Current V.S Ambient Temperature



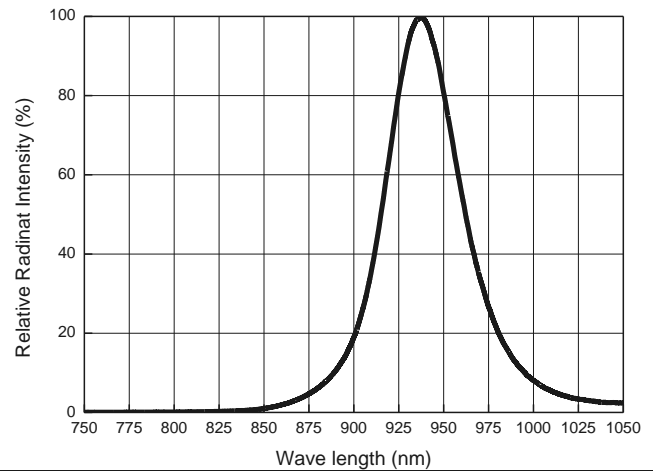
Power Dissipation vs. Ambient Temperature



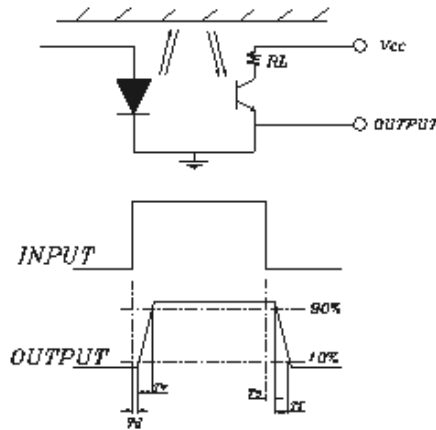
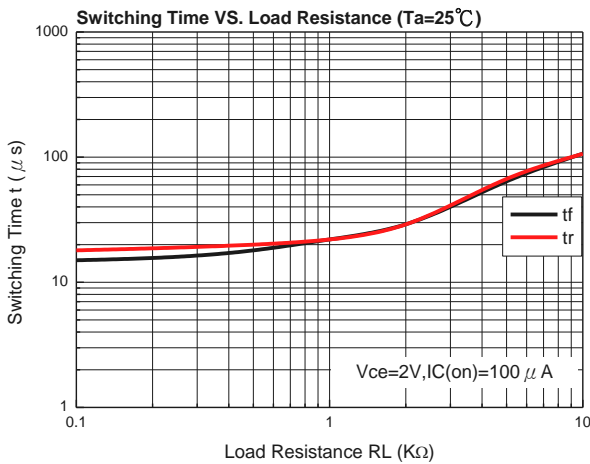
Collector Dark Current vs. Ambient Temperature



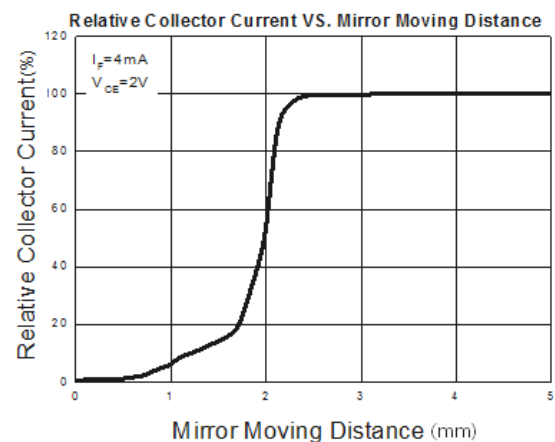
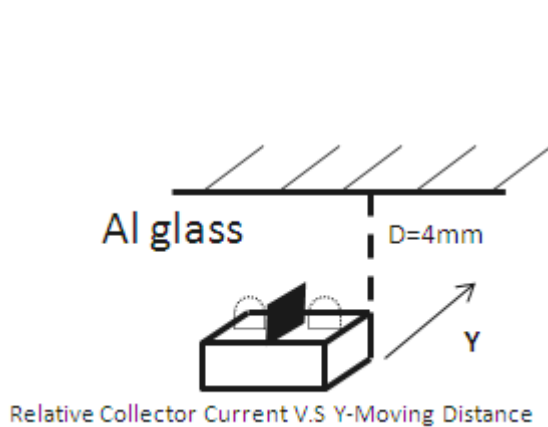
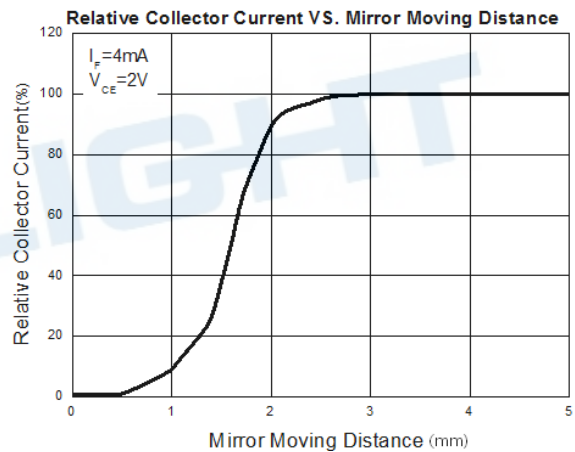
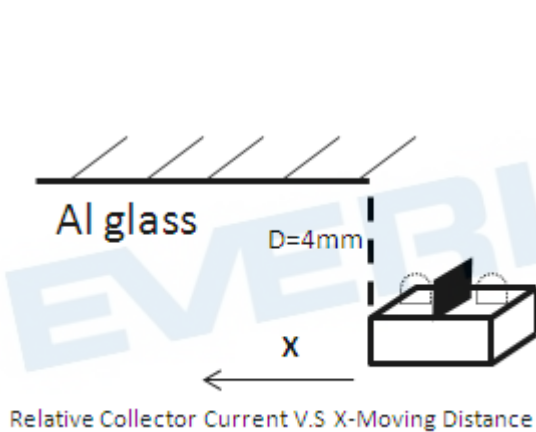
Wavelength

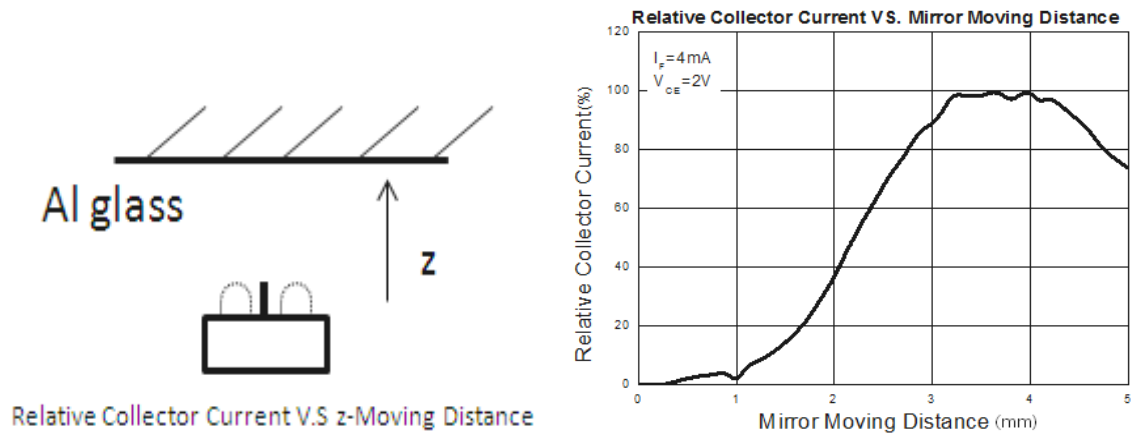


Measuring Circuit For Response Time

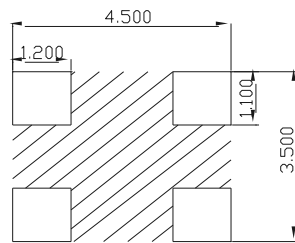


Test Condition and Arrangement for Collector Current





Recommended pattern



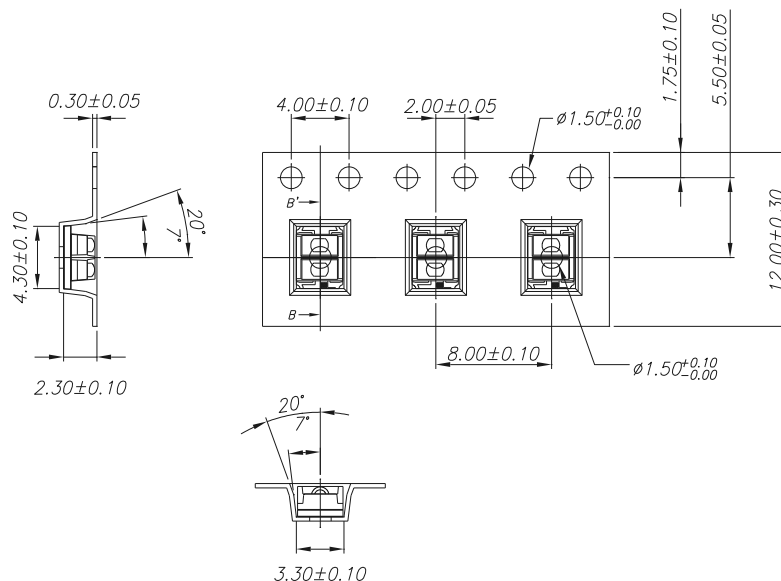
area : Please do not apply the pattern wiring to avoid the possibility of short circuit.

Regarding amount of solder, if there is solder leakage in terminal wiring pattern between PCB and housing main body, the reliability will be deteriorated.

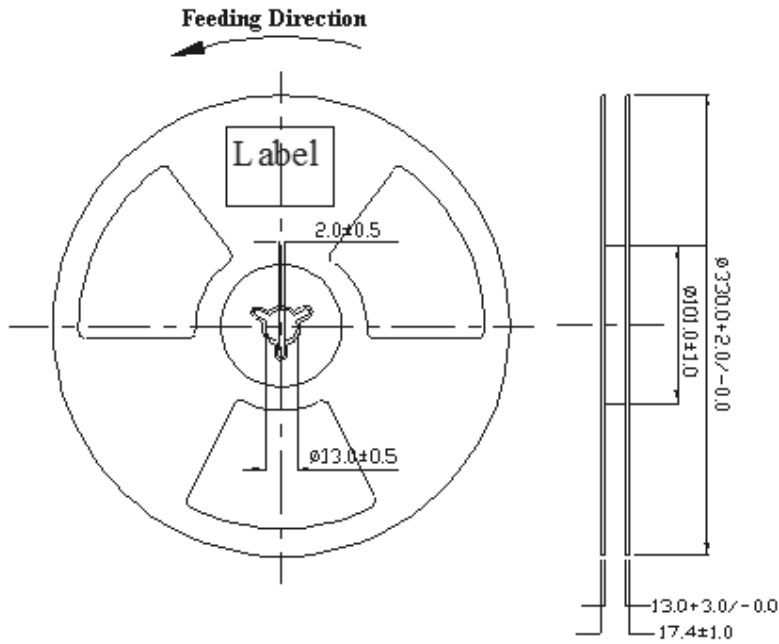
Please check the proper amount of solder in advance not to have solder leakage into terminal wiring pattern between PCB and housing main body.

Package specification

- Tape and Reel package



Reel Dimensions

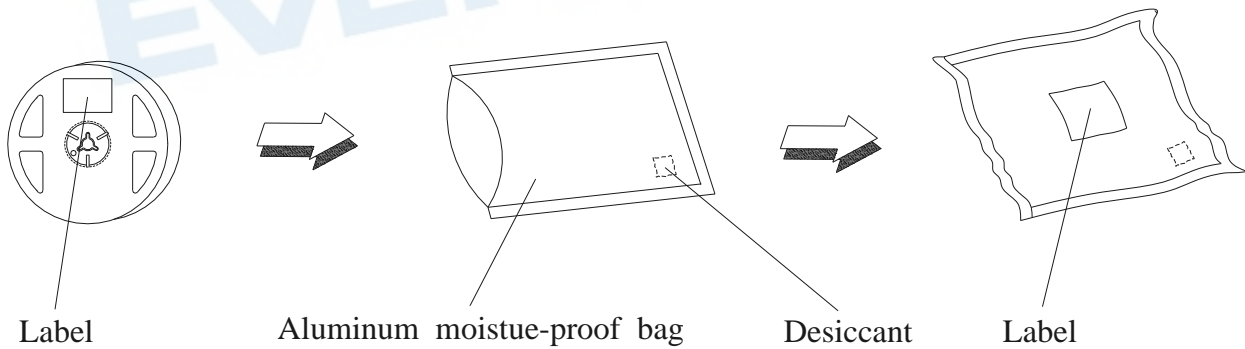


Note: The tolerances unless mentioned is $\pm 1.0\text{mm}$, Unit = mm

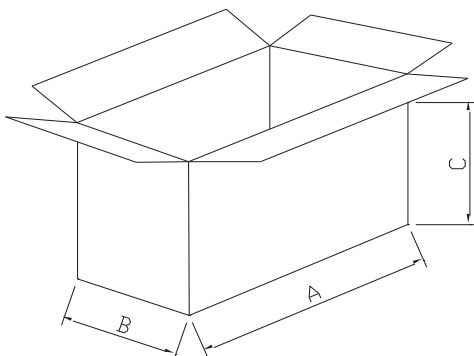
Packing Quantity Specification

- 800pcs / 1 Reel
- 38 Reels / 1 Carton

Packing Procedure



Outer Carton Dimension : 409mm(A)*245mm(B)*360mm(C)



Recommended Method of Storage

The following are general recommendations for moisture sensitive level (MSL) 3 storage and use :

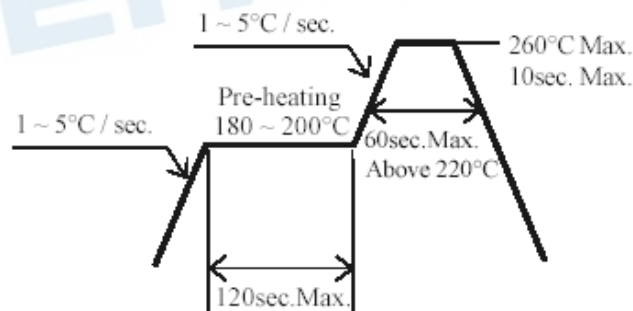
1. Storage

- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the device should be kept at 30°C or less and 90%RH or less.
- 1.3 The device should be used within a year.
- 1.4 After opening the package, the device should be kept at 30°C or less and 70%RH or less.
- 1.5 The device should be used within 168 hours (7 days) after opening the package.
- 1.6 If the moisture absorbent material (silica gel) has faded away or the device have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm 5^{\circ}\text{C}$ for 24 hours.

2. Soldering Condition

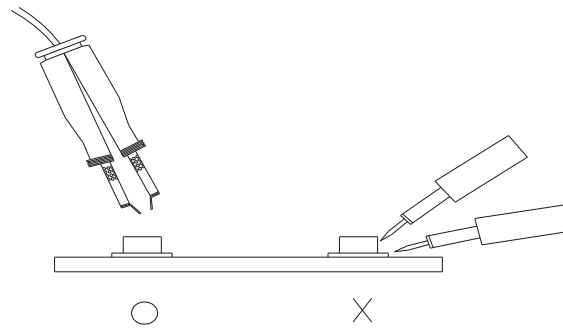
a) Pb-free solder temperature profile



- b) Reflow soldering should not be done more than two times.
- c) When soldering, do not put stress on the Device during heating.
- d) After soldering, do not warp the circuit board.


Repairing

Repair should not be done after the Device have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the Device will or will not be damaged by repairing.



Label Form Specification

RoHS (Pb) EVERLIGHT	
CPN: XXXXXXXX	
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX	
P/N:	
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX	
LOT NO:	
XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	
QTY:	HUE:
CAT:	REF:
REFERENCE:	



CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Disclaimer

- 1.EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2.The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3.The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4.When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5.These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- 6.This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.